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FAIRCHILD

SEMICONDUCTOR TM

FQB17N08 / FQI17N08 **80V N-Channel MOSFET**

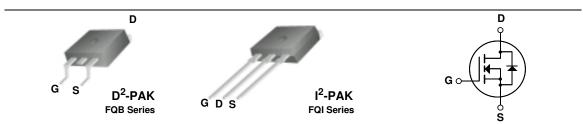
General Description

These N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, planar stripe, DMOS technology.

This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand a high energy pulse in the avalanche and commutation modes. These devices are well suited for low voltage applications such as automotive, high efficiency switching for DC/DC converters, and DC motor control.

Features

- + 16.5A, 80V, $R_{DS(on)} = 0.115\Omega @V_{GS} = 10 V$ + Low gate charge (typical 12 nC)
- Low Crss (typical 28 pF) •
- Fast switching
- 100% avalanche tested
- Improved dv/dt capability
- 175°C maximum junction temperature rating



Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Parameter		FQB17N08 / FQI17N08	Units
V _{DSS}	Drain-Source Voltage		80	V
ID	Drain Current - Continuous ($T_C = 25^{\circ}$	C)	16.5	А
	- Continuous (T _C = 100)°C)	11.6	А
I _{DM}	Drain Current - Pulsed	(Note 1)	66	А
V _{GSS}	Gate-Source Voltage		± 25	V
E _{AS}	Single Pulsed Avalanche Energy	(Note 2)	100	mJ
I _{AR}	Avalanche Current	(Note 1)	16.5	А
E _{AR}	Repetitive Avalanche Energy	(Note 1)	6.5	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)		6.5	V/ns
PD	Power Dissipation $(T_A = 25^{\circ}C)^{*}$		3.13	W
	Power Dissipation $(T_C = 25^{\circ}C)$		65	W
- Derate above 25°C		0.43	W/°C	
T _J , T _{STG}	Operating and Storage Temperature Range		-55 to +150	°C
TL	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

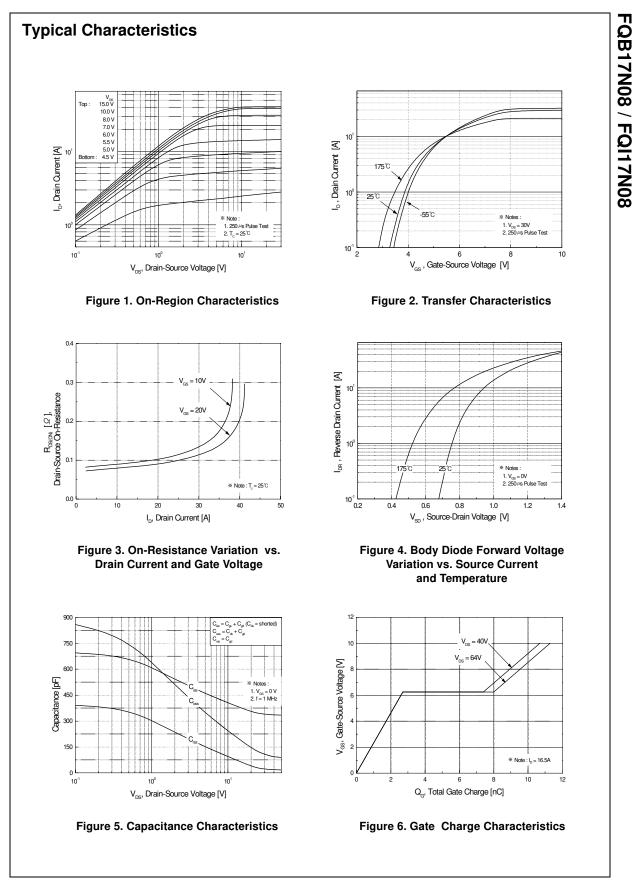
Symbol	Parameter	Тур	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		2.31	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient *		40	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient		62.5	°C/W

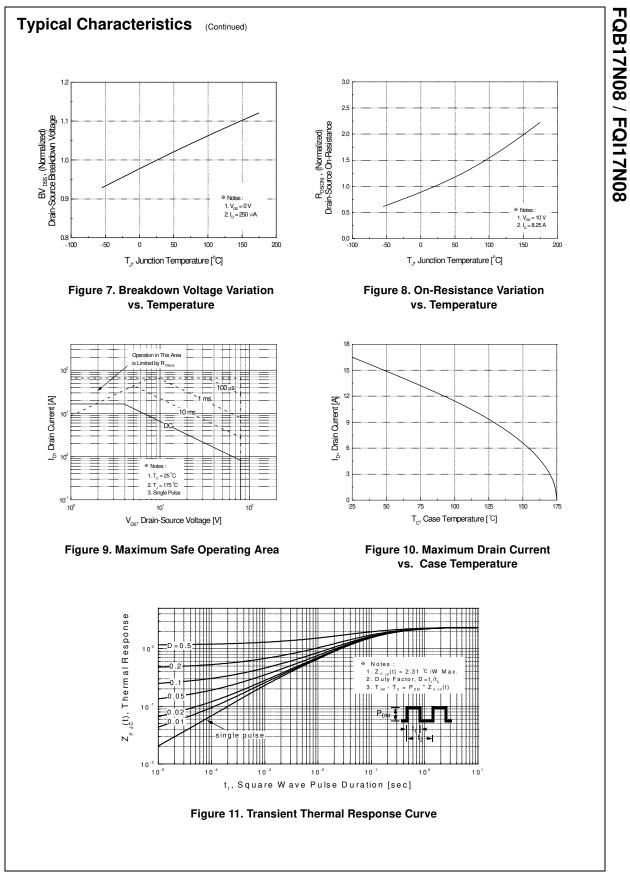
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January 2001

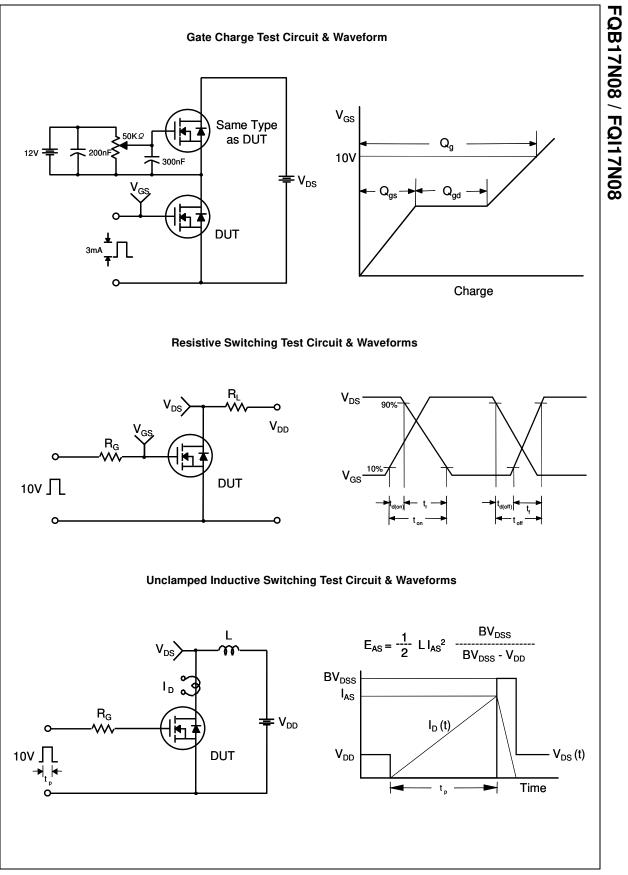
Symbol	Parameter	Test Conditions	6	Min	Тур	Max	Units
Off Cha	aracteristics						
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$		80			V
ΔBV_{DSS} / ΔT_{J}	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu A$, Referenced	l to 25°C		0.08		V/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$				1	μA
		V _{DS} = 64 V, T _C = 150°C				10	μA
I _{GSSF}	Gate-Body Leakage Current, Forward	$V_{GS} = 25 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
I _{GSSR}	Gate-Body Leakage Current, Reverse	$V_{GS} = -25 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
On Cha	racteristics						
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		2.0		4.0	V
R _{DS(on)}	Static Drain-Source On-Resistance	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$ $V_{GS} = 10 \text{V}, I_D = 8.25 \text{A}$			0.088	0.115	Ω
9 _{FS}	Forward Transconductance	V _{DS} = 30 V, I _D = 8.25 A (Note 4)			5.3		S
	ic Characteristics	1			250	450	~ 5
C _{iss}	Input Capacitance	V _{DS} = 25 V, V _{GS} = 0 V, f = 1.0 MHz			350	450	pF
C _{oss} C _{rss}	Output Capacitance Reverse Transfer Capacitance				120 28	155 35	pF pF
	ng Characteristics	1		I		1	
t _{d(on)}	Turn-On Delay Time	$V_{DD} = 40 \text{ V}, \text{ I}_{D} = 16.5 \text{ A},$			4.8	20	ns
t _r	Turn-On Rise Time				60	130	ns
t _{d(off)}	Turn-Off Delay Time	R _G = 25 Ω			15	40	ns
t _f	Turn-Off Fall Time	-	(Note 4, 5)		25	60	ns
Q _q	Total Gate Charge	V _{DS} = 64 V, I _D = 16.5 A,			12	15	nC
Q _{gs}	Gate-Source Charge	$V_{GS} = 10 V$			2.7		nC
Q _{gd}	Gate-Drain Charge		(Note 4, 5)		5.4		nC
Drain-S	ource Diode Characteristics a	Ŭ	S			16.5	А
I _{SM}	Maximum Continuous Drain-Source Dide F					66	A
V _{SD}		$V_{GS} = 0 V, I_S = 16.5 A$				1.5	V
t _{rr}	Reverse Recovery Time	$V_{GS} = 0 V, I_S = 16.5 A,$ $V_{GS} = 0 V, I_S = 16.5 A,$			55		ns
		$dI_{\rm F} / dt = 100 \text{ A/}\mu\text{s}$	(Note 4)				_
$\begin{array}{l} L=0.5mH, \mbox{I}\\ I_{SD}\leq 16.5A\\ \mbox{Pulse Test}: \end{array}$	Reverse Recovery Charge ating : Pulse width limited by maximum junction tempe $A_{S} = 16.5A$, $V_{DD} = 25V$, $R_{G} = 25 \Omega$, Starting $T_{J} = 25^{\circ}C$, didd \leq 300A/µs, $V_{DD} \leq BV_{DSS}$, Starting $T_{J} = 25^{\circ}C$ Pulse width \leq 300µs, Duty cycle $\leq 2\%$ ndependent of operating temperature	rature	()		92		nC

FQB17N08 / FQI17N08

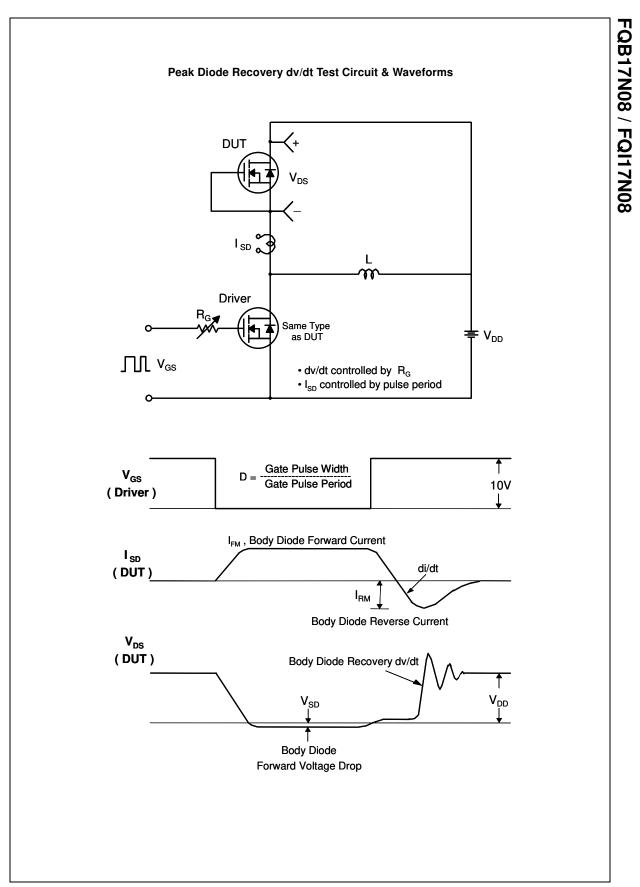


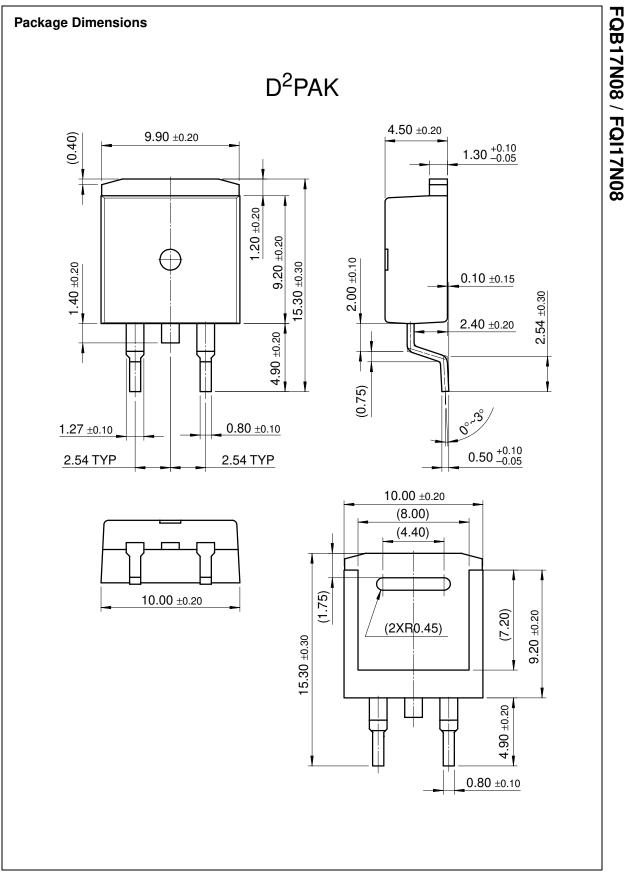


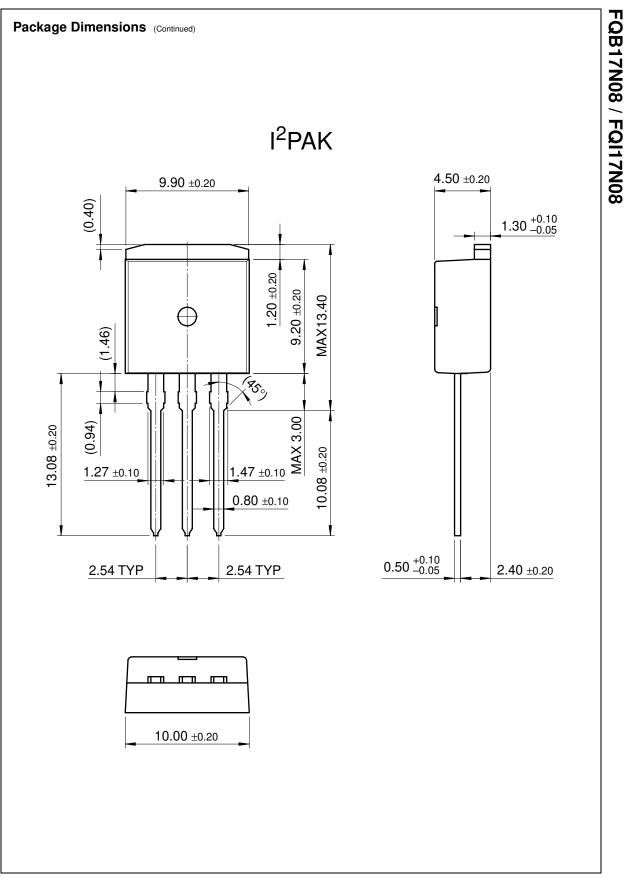
Rev. A1, January 2001



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